



Patent

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: VANDENTOP et al.

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DIE/PACKAGE INTERCONNECT

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Dated: October 14, 2005 By: Edith Martin
Edith Martin

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Restriction Requirement Action mailed October 3, 2005, Applicants respectfully submit the following remarks.